



STGF20NB60S

N-CHANNEL 13A - 600V TO-220FP

PowerMESH™ IGBT

Table 1: General Features

| TYPE | V _{CES} | V _{CE(sat)} (Max) @25°C | I _C @100°C |
|-------------|------------------|-------------------------------------|--------------------------|
| STGF20NB60S | 600 V | < 1.7 V | 13 A |

- LOW ON-VOLTAGE DROP (V_{cesat})
- HIGH CURRENT CAPABILITY
- OFF LOSSES INCLUDE TAIL CURRENT
- HIGH INPUT IMPEDANCE (VOLTAGE DRIVEN)

DESCRIPTION

Using the latest high voltage technology based on a patented strip layout, STMicroelectronics has designed an advanced family of IGBTs, the PowerMESH™ IGBTs, with outstanding performances. The suffix "S" identifies a family optimized to achieve minimum on-voltage drop for low frequency to applications (<1kHz).

APPLICATIONS

- LIGHT DIMMER
- STATIC RELAYS
- MOTOR CONTROL

Figure 1: Package

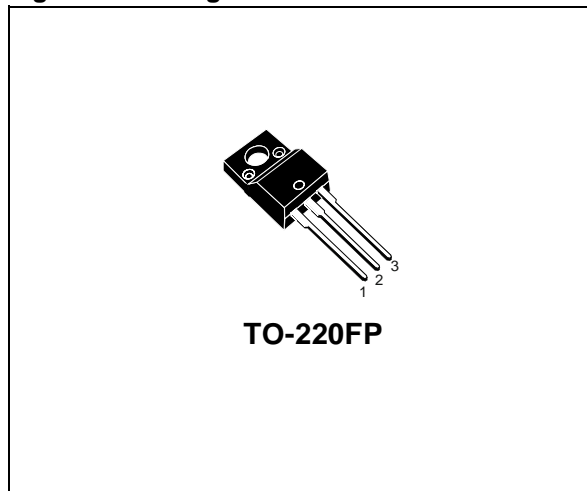


Figure 2: Internal Schematic Diagram

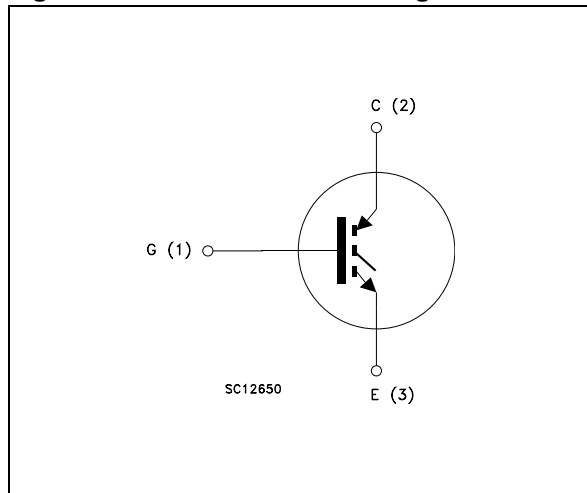


Table 2: Order Code

| PART NUMBER | MARKING | PACKAGE | PACKAGING |
|-------------|-----------|----------|-----------|
| STGF20NB60S | GF20NB60S | TO-220FP | TUBE |

Table 3: Absolute Maximum ratings

| Symbol | Parameter | Value | Unit |
|---------------------|--|------------|------|
| V _{CES} | Collector-Emitter Voltage (V _{GS} = 0) | 600 | V |
| V _{ECR} | Emitter-Collector Voltage | 20 | V |
| V _{GE} | Gate-Emitter Voltage | ±20 | V |
| I _C | Collector Current (continuous) at T _C = 25°C (#) | 24 | A |
| I _C | Collector Current (continuous) at T _C = 100°C (#) | 13 | A |
| I _{CM} (■) | Collector Current (pulsed) | 70 | A |
| P _{TOT} | Total Dissipation at T _C = 25°C | 40 | W |
| | Derating Factor | 0.32 | W/°C |
| V _{ISO} | Insulation withstand voltage AC (t=1sec, T _c =25°C) | 2500 | V |
| T _{stg} | Storage Temperature | -55 to 150 | °C |
| T _j | Operating Junction Temperature range | | |

(■) Pulse width limited by safe operating area

Table 4: Thermal Data

| | | Min. | Typ. | Max. | |
|-----------------------|--|------|------|------|------|
| R _{thj-case} | Thermal Resistance Junction-case | | | 3.15 | °C/W |
| R _{thj-amb} | Thermal Resistance Junction-ambient | | | 62.5 | °C/W |
| T _L | Maximum Lead Temperature for Soldering Purpose (1.6 mm from case, for 10 sec.) | | 300 | | °C |

ELECTRICAL CHARACTERISTICS (T_{CASE} =25°C UNLESS OTHERWISE SPECIFIED)

Table 5: On/Off

| Symbol | Parameter | Test Conditions | Min. | Typ. | Max. | Unit |
|----------------------|--|---|------|-------------|-----------|----------|
| V _{BR(CES)} | Collector-Emitter Breakdown Voltage | I _C = 250 μA, V _{GE} = 0 | 600 | | | V |
| I _{CES} | Collector cut-off Current (V _{GE} = 0) | V _{CE} = Max Rating, T _C = 25 °C V _{CE} = Max Rating, T _C = 125 °C | | | 10 100 | μA μA |
| I _{GES} | Gate-Emitter Leakage Current (V _{CE} = 0) | V _{GE} = ± 20V, V _{CE} = 0 | | | ±100 | nA |
| V _{GE(th)} | Gate Threshold Voltage | V _{CE} = V _{GE} , I _C = 250 μA | 2.5 | | 5 | V |
| V _{CE(sat)} | Collector-Emitter Saturation Voltage | V _{GE} = 15V, I _C = 20 A, T _j = 25°C V _{GE} = 15V, I _C = 20A, T _j =150°C | | 1.25 1.2 | 1.7 | V V |

(#) Calculated according to the iterative formula:

$$I_C(T_C) = \frac{T_{JMAX} - T_C}{R_{THJ-C} \times V_{CESAT(MAX)}(T_C, I_C)}$$

ELECTRICAL CHARACTERISTICS (CONTINUED)

Table 6: Dynamic

| Symbol | Parameter | Test Conditions | Min. | Typ. | Max. | Unit |
|-------------------------------|---|---|------|----------------|------|----------------|
| g_{fs} (1) | Forward Transconductance | $V_{CE} = 10 \text{ V}$, $I_C = 8 \text{ A}$ | | 20 | | S |
| C_{ies} | Input Capacitance | $V_{CE} = 25 \text{ V}$, $f = 1 \text{ MHz}$, $V_{GE} = 0$ | | 1820 | | pF |
| C_{oes} | Output Capacitance | | | 167 | | pF |
| C_{res} | Reverse Transfer Capacitance | | | 27 | | pF |
| Q_g Q_{ge} Q_{gc} | Total Gate Charge Gate-Emitter Charge Gate-Collector Charge | $V_{CC} = 480 \text{ V}$, $I_C = 20 \text{ A}$, $V_{GE} = 15 \text{ V}$ (see Figure 19) | | 83 10 27 | 115 | nC nC nC |
| I_{CL} | Turn-off SOA minimum current | $V_{clamp} = 480 \text{ V}$, $T_j = 125^\circ\text{C}$ $R_G = 100 \Omega$ | 80 | | | A |

(1) Pulsed: Pulse duration= 300 μs , duty cycle 1.5%

Table 7: Switching On

| Symbol | Parameter | Test Conditions | Min. | Typ. | Max. | Unit | |
|--|--|--|--|-----------------|-----------------|------------------------------|------------------------------|
| $t_{d(on)}$ t_r $(di/dt)_{on}$ | Turn-on Delay Time Current Rise Time Turn-on Current Slope | $V_{CC} = 480 \text{ V}$, $I_C = 20 \text{ A}$ $R_G = 100 \Omega$, $V_{GE} = 15 \text{ V}$ (see Figure 17) | | 92 70 340 | | ns ns A/ μs | |
| $t_{d(on)}$ t_r $(di/dt)_{on}$ | Turn-on Delay Time Current Rise Time Turn-on Delay Time | | $V_{CC} = 480 \text{ V}$, $I_C = 20 \text{ A}$ $R_G = 100 \Omega$, $V_{GE} = 15 \text{ V}$, $T_j = 125^\circ\text{C}$ (see Figure 17) | | 80 73 320 | | ns ns A/ μs |

Table 8: Switching Off

| Symbol | Parameter | Test Conditions | Min. | Typ. | Max. | Unit | |
|--|--|--|---|----------------------------|--------------------------|--|--|
| t_c $t_r(V_{off})$ $t_{d(off)}$ t_f | Cross-over Time Off Voltage Rise Time Turn-off Delay Time Current Fall Time | $V_{CC} = 480 \text{ V}$, $I_C = 20 \text{ A}$, $R_G = 100 \Omega$, $V_{GE} = 15 \text{ V}$ $T_J = 25^\circ\text{C}$ (see Figure 17) | | 1.6 0.78 1.1 0.79 | | μs μs μs μs | |
| t_c $t_r(V_{off})$ $t_{d(off)}$ t_f | Cross-over Time Off Voltage Rise Time Turn-off Delay Time Current Fall Time | | $V_{CC} = 480 \text{ V}$, $I_C = 20 \text{ A}$, $R_G = 100 \Omega$, $V_{GE} = 15 \text{ V}$ $T_j = 125^\circ\text{C}$ (see Figure 17) | | 2.4 1.1 2.4 1.2 | | μs μs μs μs |

Table 9: Switching Energy

| Symbol | Parameter | Test Conditions | Min. | Typ. | Max. | Unit |
|---|---|--|--|---------------------|----------------------|----------------|
| E_{on} (2) E_{off} (3) E_{ts} | Turn-on Switching Losses Turn-off Switching Loss Total Switching Loss | $V_{CC} = 480 \text{ V}$, $I_C = 20 \text{ A}$ $R_G = 100 \Omega$, $V_{GE} = 15 \text{ V}$, (see Figure 18) | | 0.84 7.4 8.24 | | mJ mJ mJ |
| E_{on} (2) E_{off} (3) E_{ts} | Turn-on Switching Losses Turn-off Switching Loss Total Switching Loss | | $V_{CC} = 480 \text{ V}$, $I_C = 20 \text{ A}$ $R_G = 100 \Omega$, $V_{GE} = 15 \text{ V}$, $T_j = 125^\circ\text{C}$ (see Figure 18) | | 0.86 11.5 12.4 | |

(2) E_{on} is the turn-on losses when a typical diode is used in the test circuit in figure 2. If the IGBT is offered in a package with a co-pack diode, the co-pack diode is used as external diode.

(3) Turn-off losses include also the tail of the collector current.

Figure 3: Output Characteristics

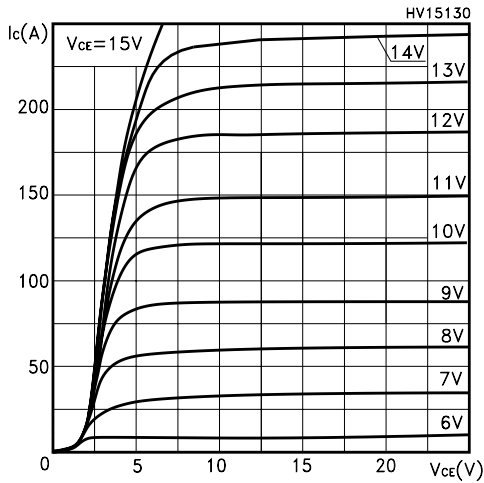


Figure 4: Transconductance

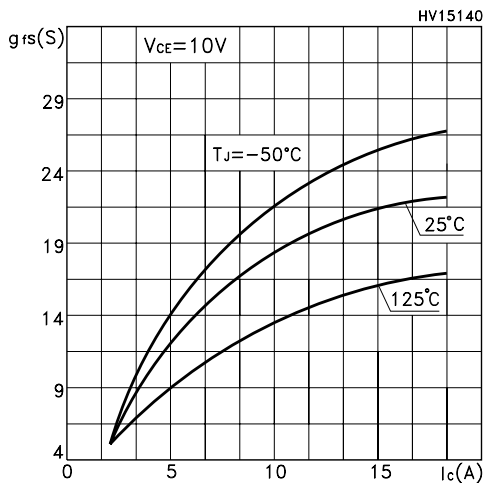


Figure 5: Collector-Emitter On Voltage vs Collector Current

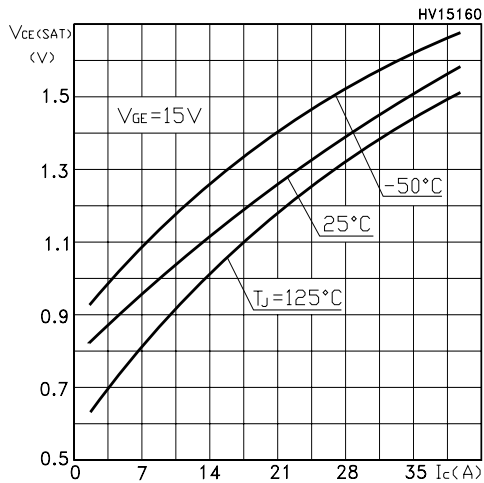


Figure 6: Transfer Characteristics

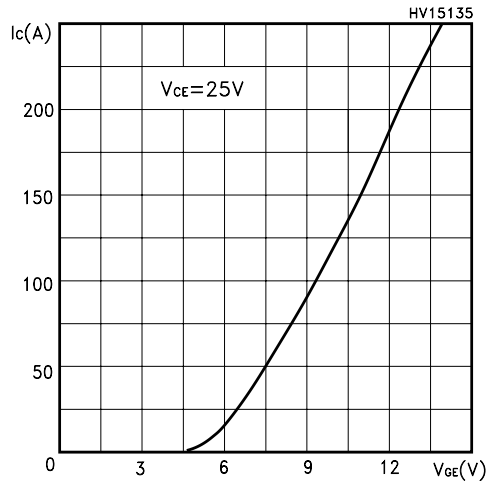


Figure 7: Normalized Collector-Emitter On Voltage vs Temperature

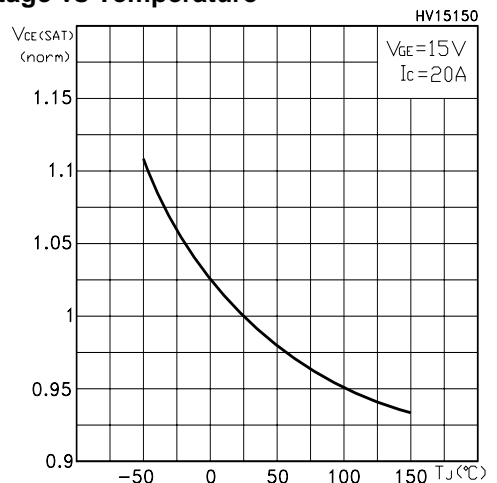


Figure 8: Gate Threshold vs Temperature

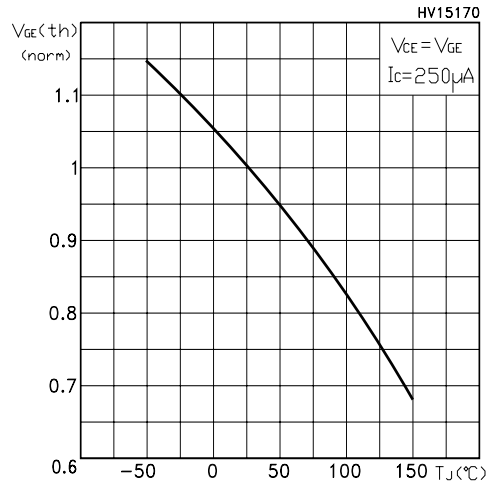


Figure 9: Normalized Breakdown Voltage vs Temperature

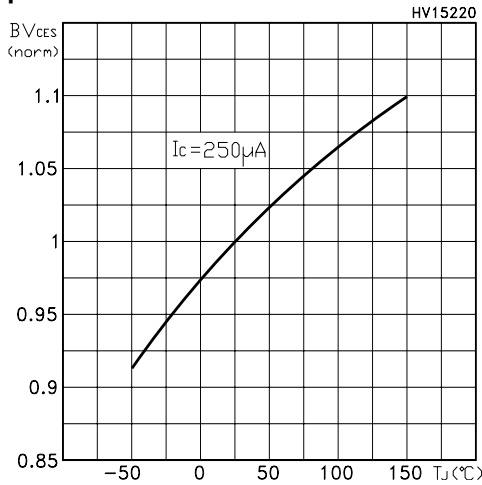


Figure 10: Capacitance Variations

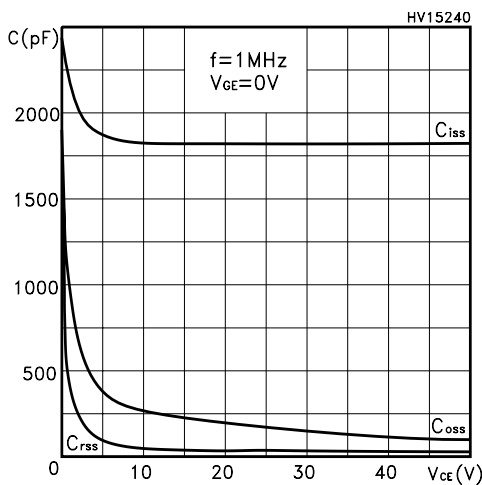


Figure 11: Switching Losses vs Temperature

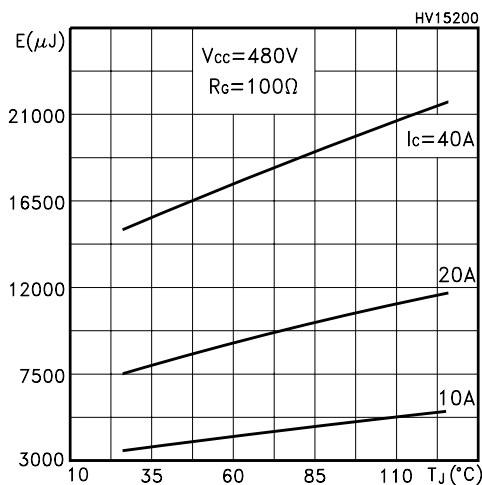


Figure 12: Gate Charge vs Gate-Emitter Voltage

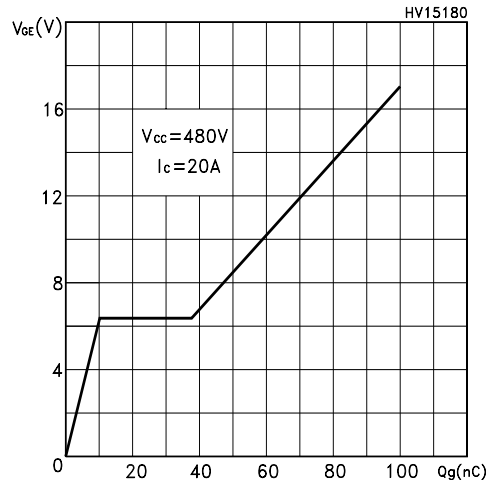


Figure 13: Switching Losses vs Gate Charge

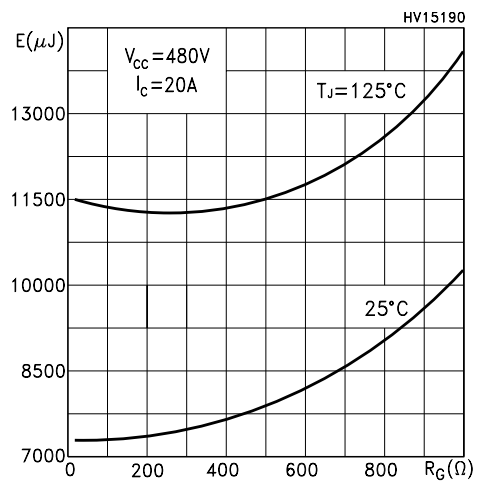


Figure 14: Switching Losses vs Collector Current

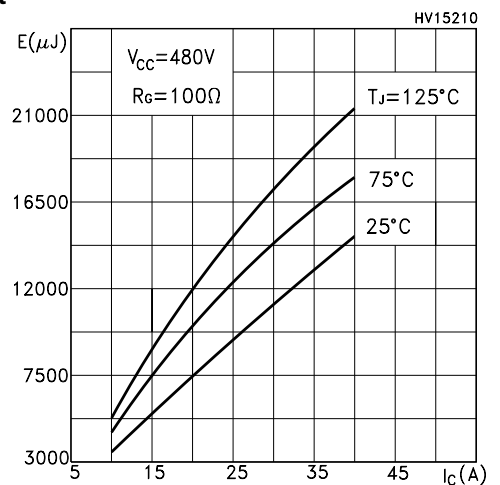


Figure 15: Thermal Impedance

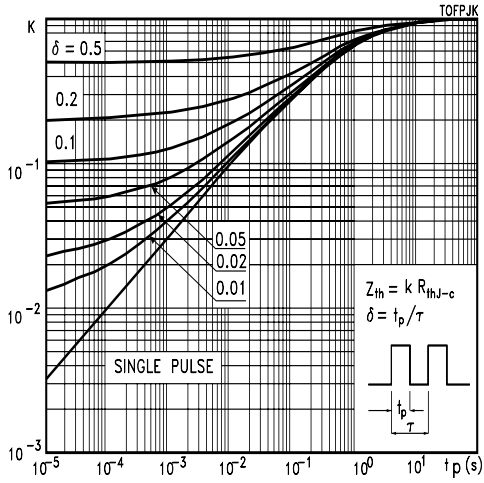


Figure 16: Collector-Emitter Diode Characteristics

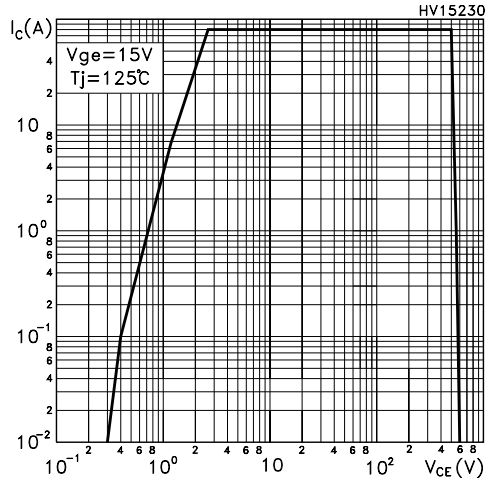


Figure 17: Test Circuit for Inductive Load Switching

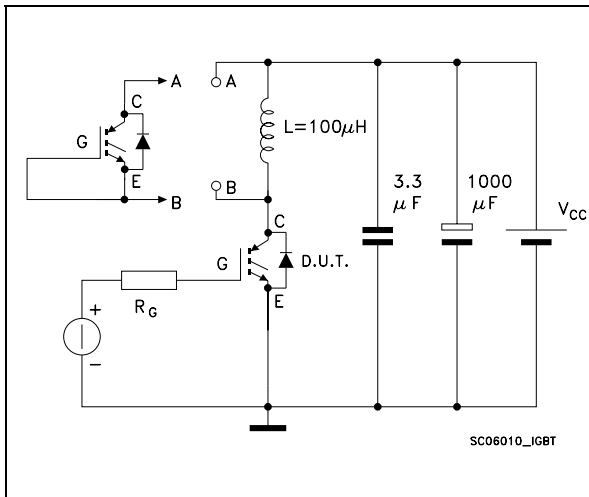


Figure 18: Switching Waveforms

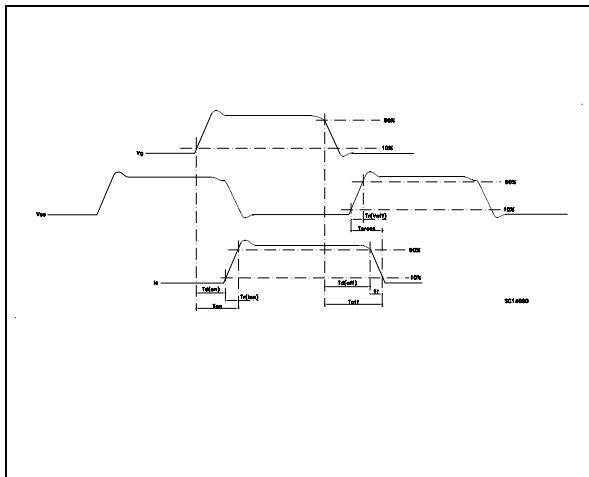
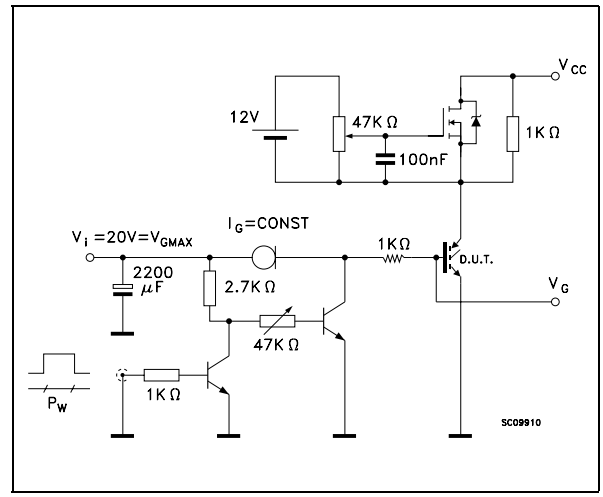


Figure 19: Gate Charge Test Circuit



In order to meet environmental requirements, ST offers these devices in ECOPACK® packages. These packages have a Lead-free second level interconnect . The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: www.st.com

TO-220FP MECHANICAL DATA

| DIM. | mm. | | | inch | | |
|------|------|------|------|-------|-------|-------|
| | MIN. | TYP. | MAX. | MIN. | TYP. | MAX. |
| A | 4.4 | | 4.6 | 0.173 | | 0.181 |
| B | 2.5 | | 2.7 | 0.098 | | 0.106 |
| D | 2.5 | | 2.75 | 0.098 | | 0.108 |
| E | 0.45 | | 0.7 | 0.017 | | 0.027 |
| F | 0.75 | | 1 | 0.030 | | 0.039 |
| F1 | 1.15 | | 1.7 | 0.045 | | 0.067 |
| F2 | 1.15 | | 1.7 | 0.045 | | 0.067 |
| G | 4.95 | | 5.2 | 0.195 | | 0.204 |
| G1 | 2.4 | | 2.7 | 0.094 | | 0.106 |
| H | 10 | | 10.4 | 0.393 | | 0.409 |
| L2 | | 16 | | | 0.630 | |
| L3 | 28.6 | | 30.6 | 1.126 | | 1.204 |
| L4 | 9.8 | | 10.6 | .0385 | | 0.417 |
| L5 | 2.9 | | 3.6 | 0.114 | | 0.141 |
| L6 | 15.9 | | 16.4 | 0.626 | | 0.645 |
| L7 | 9 | | 9.3 | 0.354 | | 0.366 |
| Ø | 3 | | 3.2 | 0.118 | | 0.126 |

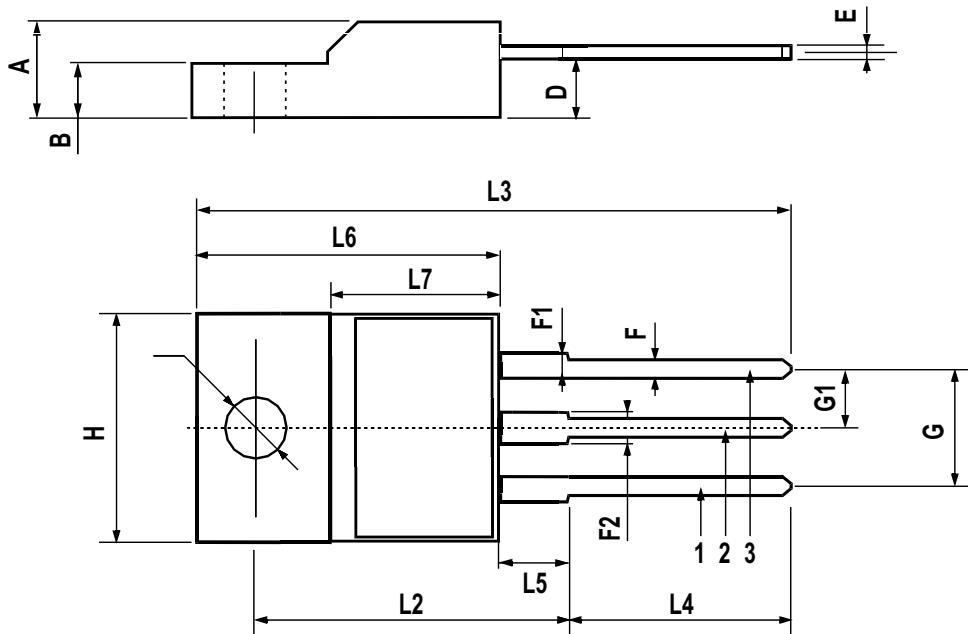


Table 10: Revision History

| Date | Revision | Description of Changes |
|-------------|-----------------|---------------------------------|
| 17-Dec-2004 | 2 | New template, no content change |
| 05-Aug-2005 | 3 | Some values changed in table 6 |

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